



# CEDF634/CEUF634

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

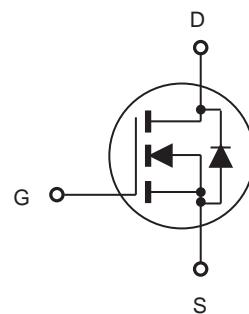
- 250V, 6.7A,  $R_{DS(ON)} = 450\text{m}\Omega$  @  $V_{GS} = 10\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Lead free product is acquired.
- TO-251 & TO-252 package.



CEU SERIES  
TO-252(D-PAK)



CED SERIES  
TO-251(I-PAK)



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	250	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current-Continuous	$I_D$	6.7	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	26	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	$P_D$	46 0.37	W W/ $^\circ\text{C}$
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	2.7	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	50	$^\circ\text{C}/\text{W}$



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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	250			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 250\text{V}, V_{\text{GS}} = 0\text{V}$		25		$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 5.1\text{A}$		450		$\text{m}\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 50\text{V}, I_D = 5.1\text{A}$		4.4		S
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		630		pF
Output Capacitance	$C_{\text{oss}}$			100		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			40		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 125\text{V}, I_D = 5.6\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 12\Omega$		19	40	ns
Turn-On Rise Time	$t_r$			11	30	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			46	90	ns
Turn-Off Fall Time	$t_f$			10	30	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 200\text{V}, I_D = 5.6\text{A}, V_{\text{GS}} = 10\text{V}$		26	33	nC
Gate-Source Charge	$Q_{\text{gs}}$			5		nC
Gate-Drain Charge	$Q_{\text{gd}}$			11		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				8.1	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 8.1\text{A}$		0.9	1.5	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature.
- b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- c.Guaranteed by design, not subject to production testing.

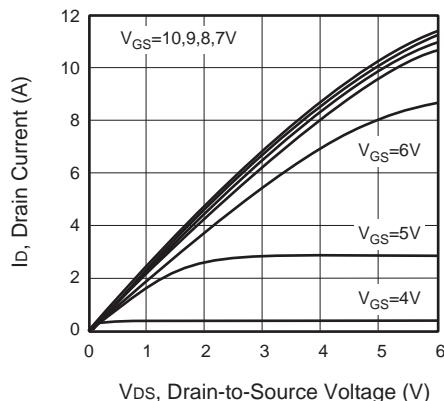


Figure 1. Output Characteristics

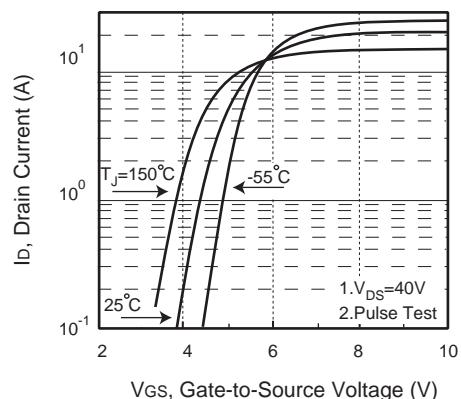


Figure 2. Transfer Characteristics

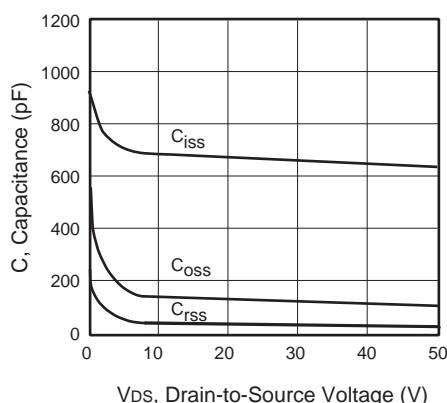


Figure 3. Capacitance

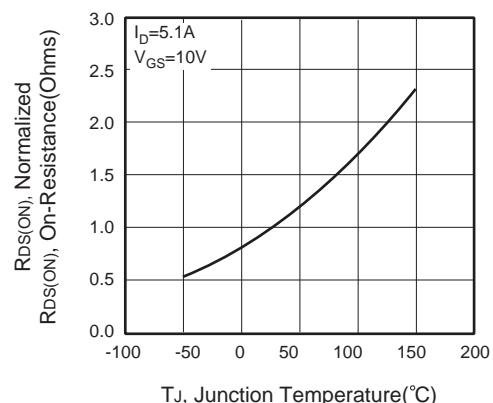


Figure 4. On-Resistance Variation with Temperature

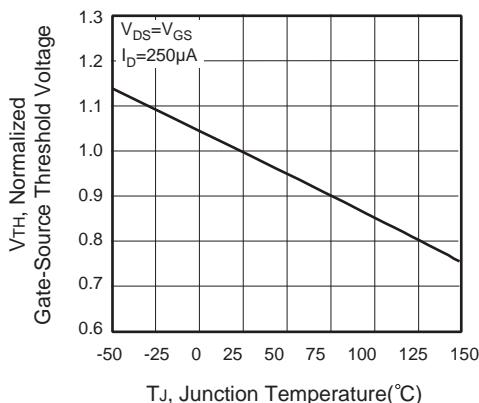


Figure 5. Gate Threshold Variation with Temperature

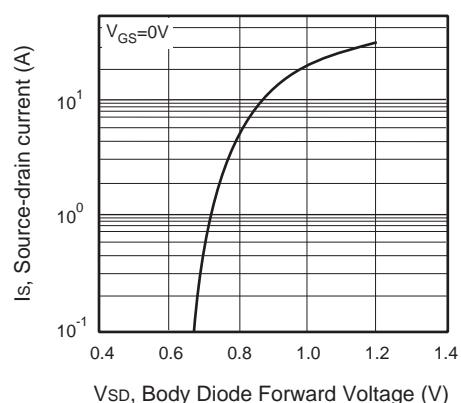
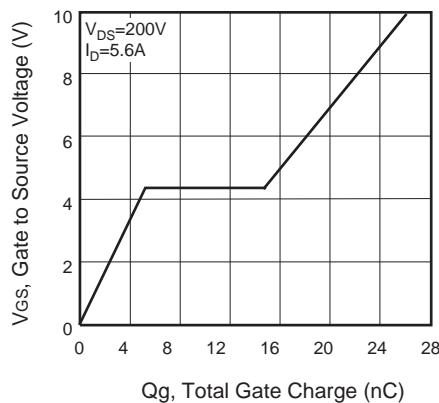
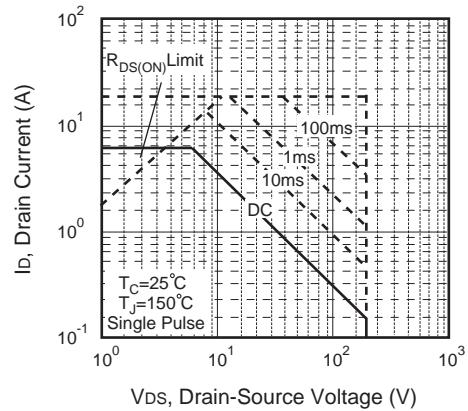


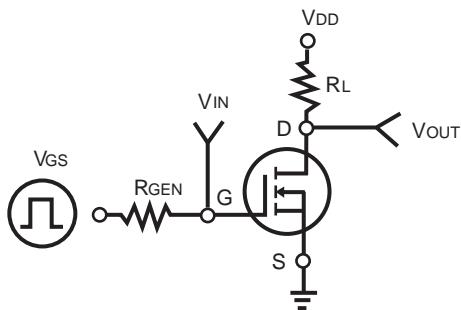
Figure 6. Body Diode Forward Voltage Variation with Source Current



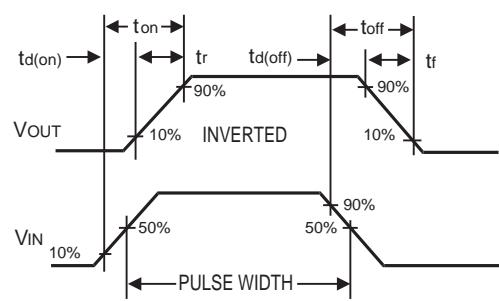
**Figure 7. Gate Charge**



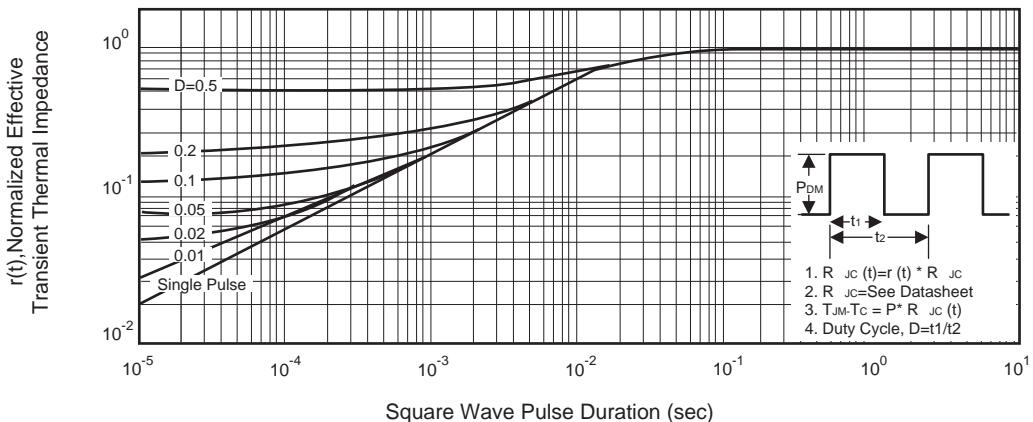
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Switching Test Circuit**



**Figure 10. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**